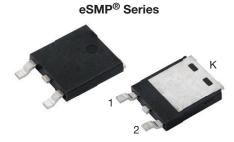
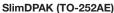


Vishay General Semiconductor

Surface-Mount ESD Capability Rectifier



www.vishay.com





LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
2 x 3 A					
100 V, 200 V, 400 V, 600 V					
42 A					
0.94 V					
175 °C					
SlimDPAK (TO-252AE)					
Common cathode					

FEATURES

- Very low profile typical height of 1.3 mm
- · Ideal for automated placement
- · Oxide planar chip junction
- · Low forward voltage drop
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

AUTOMOTIVE

RoHS

COMPLIANT

HALOGEN FREE

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both industry and automotive applications.

MECHANICAL DATA

Case: SlimDPAK (TO-252AE)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102, M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER		SYMBOL	SE60PWBC	SE60PWDC	SE60PWGC	SE60PWJC	UNIT
Device marking code			SE60PWBC	SE60PWDC	SE60PWGC	SE60PWJC	
Maximum repetitive peak reverse voltage		V_{RRM}	100	200	400	600	V
Maximum average forward rectified current (fig. 1) per device per diode		I _{F(AV)} (1)	6				A
		IF(AV) \ '	3				
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load		I _{FSM}	42			Α	
Peak forward surge current 1 ms square wave on rated load				8	0		Α
Operating junction and storage temperature range		T _J , T _{STG}	-55 to +175				°C

(1) With infinite heatsink



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Maximum Instantaneous forward voltage	I _F = 1.5 A	- T _A = 25 °C	V _F ⁽¹⁾	0.94	-	V	
	I _F = 3.0 A			1.03	1.1		
	I _F = 1.5 A	T _A = 125 °C		0.84	-		
	I _F = 3.0 A		IA = 125 C	0.94	1.01		
Reverse current	Datad V	T _A = 25 °C	1 (2)	=	10		
	Rated V _R	T _A = 125 °C	I _R ⁽²⁾	12	150	μΑ	
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	1200	-	ns	
Typical junction capacitance	4.0 V, 1 MHz		CJ	22	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: pulse width \leq 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER SYMBOL SE60PWBC SE60PWDC SE60PWGC SE60PWJC UNIT					UNIT		
Typical thermal resistance per device	R ₀ JA (1)(2)	63				°C/W	
Typical thermal resistance per device	R _{0JM} (3)	2.3				C/VV	

Notes

- (1) The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
- $^{(2)}$ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ junction to ambient
- $^{(3)}$ Mounted on infinite heat sink; thermal resistance $R_{\theta JM}$ junction-to-mount

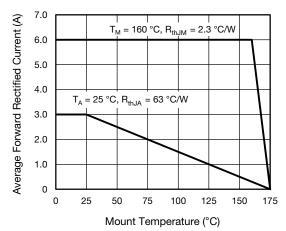
IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25~^{\circ}\text{C}$ unless otherwise noted)							
STANDARD TEST TYPE TEST CONDITIONS SYMBOL CLASS VALUE							
AEC-Q101-001	Human body model (contact mode)	$C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$	V _C	H3B	> 8 kV		

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
SE60PWJC-M3/I	0.20	I	4500	13" diameter plastic tape and reel			
SE60PWJCHM3/I (1)	0.20	I	4500	13" diameter plastic tape and reel			

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)



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Fig. 1 - Maximum Forward Current Derating Curve

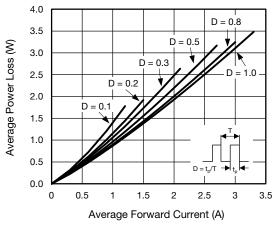


Fig. 2 - Forward Power Loss Characteristics

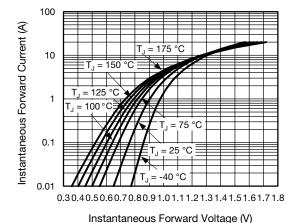


Fig. 3 - Typical Instantaneous Forward Characteristics

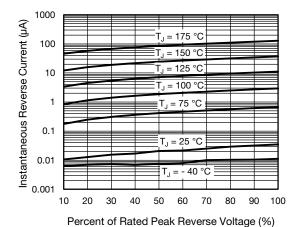


Fig. 4 - Typical Reverse Leakage Characteristics

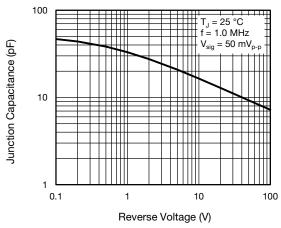


Fig. 5 - Typical Junction Capacitance

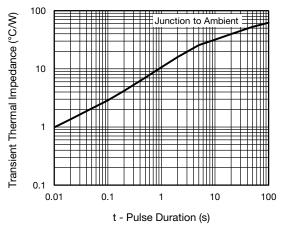


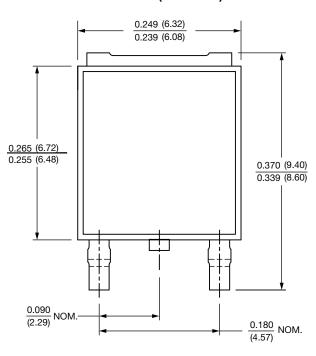
Fig. 6 - Typical Transient Thermal Impedance

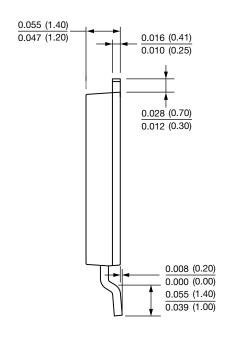


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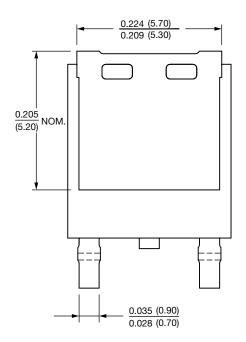
PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

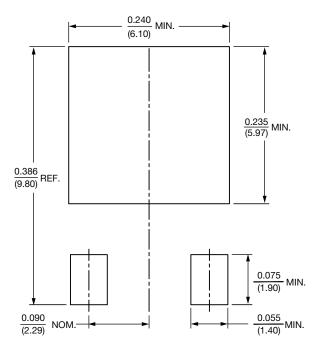
SlimDPAK (TO-252AE)





Mounting Pad Layout







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